### Specification for the Guide Field Bank Modules Capacitor Charge/Discharge Power Supply (CCDPS) for FLARE

March 15, 2016

### Contents

1	Specifications for Guide Field (GF) bank modules	4
	1.1 Description	 . 4
	1.2 Full Assembly: module	 6
	1.3 Capacitors	 . 7
	1.4 Forward Switch	 . 7
	1.5 Crowbar Switch	 . 7
	1.6 Buswork	 . 8
	1.7 Charging	 . 8
	1.8 Dump	 . 9
	1.9 Harnessing	 . 10
	1.10 Polarity switching	 . 10
	1.11 Diagnostics	 . 11
	1.12 Safety	
	1.13 Cooling requirements	 . 11
	1.14 Connections	 . 11
	1.15 Environmental requirements	 . 12
2	References	13
3	Appendices	13
J	3.1 Engineering Drawings	
	J.I DIE INCOLNE DIAMINES	 . то

т •		C		1 1	
Lis	11:	Λt	്   `ഉ	h	ΔC
-110	) U	OI.	$\perp c$	しししょ	

1 2	Target parameters for GF bank
List	of Figures
1	Guide Field Circuit Schematic
2	Spice Schematic of Guide Field at 20 kV
3	Engineering design point for bank module
4	Capacitor detail
5	Engineering design point for bank module
6	Diode detail
7	Buswork for GF bank
8	Charging switch and connection detail
9	Dump detail for the GF bank module
10	Polarity switch concept
11	Connections
12	Schematic for charge, dump and ground relay control
13	GF Bleed Resistor Channel
14	Ignitron Cage - Copper
15	Ignitron Cage - Stainless
16	GF Bus Upper
17	GF Bus Lower
18	GF Bus Clamps
19	GF Bus Insulation
20	GF Bus Vertical Support
21	GF Bus Vertical
22	GF Bus Resistor
23	GF Cable Header
24	GF Cable Header Lower
25	Outer Triax Connector
26	Inner Triax Connector
27	Dump Lid
28	Dump Stick Eyehook Bracket

### 1 Specifications for Guide Field (GF) bank modules

### 1.1 Description

Bank schematic is shown in Fig. 1. Starting on the left side of the figure, the module is charged by connecting both positive and negative supply lines. A power supply protection circuit is shown (although the components are distributed between the charge supply rack and the capacitor modules – please refer to the Charge Specification for details). A bleed resistor is connected in parallel with each capacitor and is used to slowly drain bank charge in case of failure of all other dumps (i.e. if left alone overnight the bank will passively discharge below the NFPA 70E safe approach threshold of 50 V). Before each shot, the dump load relays are opened. Then the charging relays are closed and the charging supply charges the caps. When the set-point is reached, the charging switches are opened. The capacitors are then discharged through the inductive and resistive load of the coil, and crowbarred with a delay corresponding to peak current. For GF the first swing current will always be greater than zero so a uni-polar crow bar switch (i.e., diode commutation) may be used. Following a shot, the dump switch is closed to ensure the capacitors are fully discharged. Capacitor fuses are thin wires designed to blow during an over-current event. They will be used on each cap and will connect the capacitor to the busbar. Each of the components will be described in the following sections.

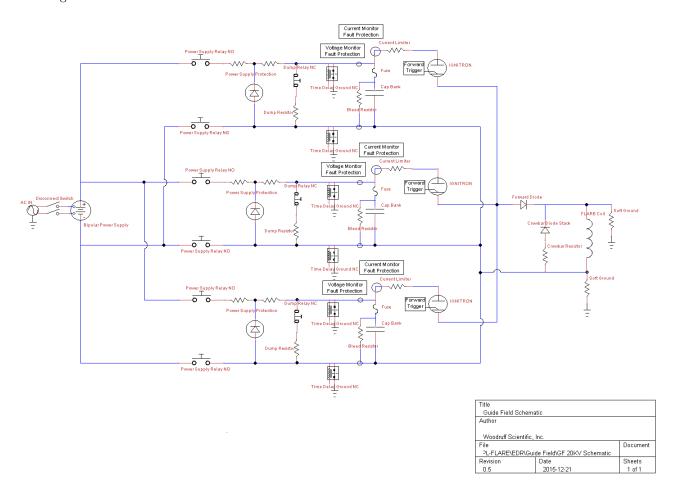
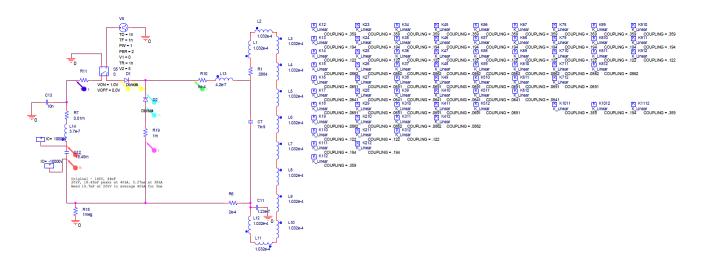


Figure 1: Guide Field Circuit Schematic

The GF bank modules are designed to energize the GF coil set, providing a current pulse per Fig. 2, meeting the specifications in Table 1. The power supply system shall be designed for a minimum of 10 years design life and a minimum of 100,000 full power shots with regular maintenance.

	GF
# Sub-Coils	1
V (Volts)	20000
Imax(A)	40000
Day 1	20%Peak I (kA)
40	
trise (ms)	< 0.45
tcrowbar	Peak
Swing Imin	+ve

Table 1: Target parameters for GF bank



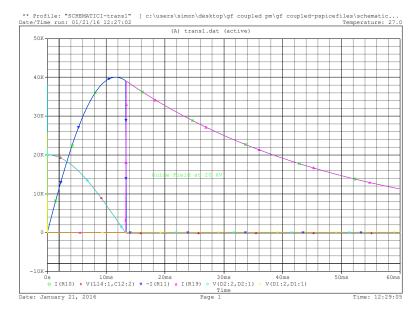
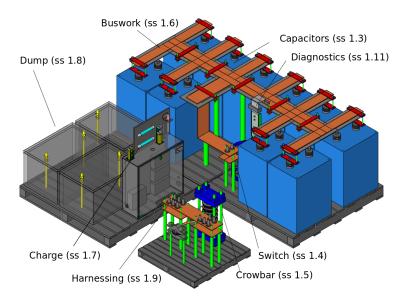


Figure 2: Spice Schematic of Guide Field at  $20~\mathrm{kV}$ 

### 1.2 Full Assembly: module

Fig. 3 shows one module of the bank assembly mounted on three 48 inch square steel pallets.



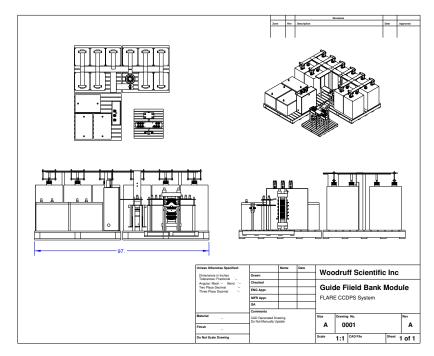


Figure 3: Engineering design point for bank module

The full assembly must not have a footprint greater than 32sqft with a maximum of 64sqft for egress and maintenance, and must be engineered as a module that can be transported and installed onsite with only a small number of connections (connections for 110V power, etc). The GF Bank and all related components will be mounted on 3 sets of 3 48"x48" standard pallets and one 36" by 36" pallet, total height under 50 inches, total weight per pallet of 1200lbs. Assembly instructions will be provided separately.

### 1.3 Capacitors

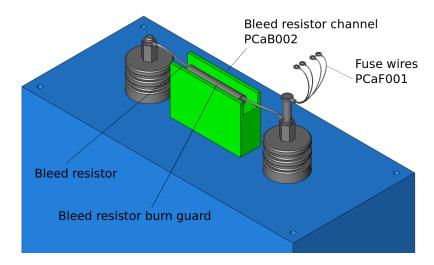


Figure 4: Capacitor detail

The capacitors will not experience voltage reversal as diodes are used in the crowbar circuit and protecting the forward switch. Each capacitor unit should be individually fused and self-protected. Energy dumping resistor(s) shall be specified for safe dissipation of stored energy (see below). The dissipation time should be limited to the shorter of the relevant industrial standards or the experimental needs. The GF bank will use 30 NL640-20KV Capacitors, by Richardson Electronics. They have a rated capacitance of 640uF and a rated voltage of 20kVDC. They are rated for 0% discharge voltage reversal. The capacitors are expected to survive at least 500,000 full power shots without failure, per cap manufacturer specification see appendix for the Richardson specification. In parallel with each capacitor is a bleed resistor. These are a redundant dump mechanism for the stored energy. These resistors are sized to discharge the bank to below 50 volts over 12 hours. The bleed resistors are a passive "last resort" safing mechanism in case of failure of the water dump or loss of buswork connections, allowing the operator to leave the bank overnight to dissipate its stored energy. The bleed resistor shown in Fig. 4 is a 45kV 45W 200k $\Omega$  Ohmite MOX-H (see spec in appendix). Shown also in Fig. 4 are the fuse wires, which are 4 16AWG bare copper wires soldered into ring terminals. Burn guard will be mounted to the cap with double-sided adhesive tape (e.g. 3M Command Strips).

### 1.4 Forward Switch

Wherever practical and appropriate, PPPL prefers the following ignitron to be used. Ignitron model NL8900, by Richardson Electronics (see appendix). For the this bank, the forward switch will be such an ignitron. The ignitrons are expected to see reverse voltage and pulse currents. Life time of the ignitron contact shall not be significantly shortened or the minimum design life of the equipment should be maintained. The ignitrons are expected to survive a minimum of 10,000 full power shots without failure. The anode of the ignitron requires heating. This design will utilize a 500W infrared heater mounted close to the anode. The ignitron requires water cooling, provided by 1/4" NPT hose connected to a water chiller. Ignitrons are connected to the bus bar using 3 copper braids terminated with ring terminals and bolted with 1/4-20 bolts (see machining drawings for details).

### 1.5 Crowbar Switch

The crowbar for the GF bank modules consists of a series stack of 6 diodes; part number 5SDD 54N4000 manufactured by ABB Semiconductors.  $350k\Omega$  Ohmite MOX-F resistors are connected in parallel across each diode to ensure the voltage is shared evenly. After the forward switch is fired, the diodes will not conduct until the current peak is reached effectively crowbarring the circuit at maximum current.

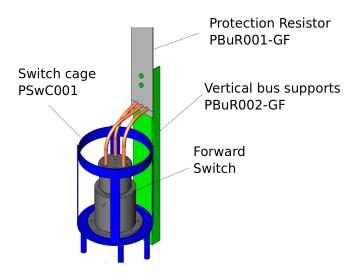


Figure 5: Engineering design point for bank module

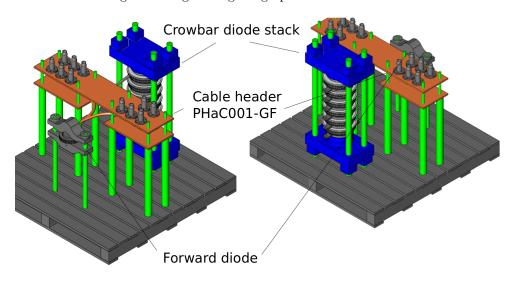


Figure 6: Diode detail

### 1.6 Buswork

Buswork consists of busbars connected to the caps by use of brass adapters that are secured by 1/4-20 bolts and have knife-edges that will bite into the copper busbars (see detailed call-out in Fig. 7. A larger bus is used to interconnect all the smaller capacitor buses which then feeds into the current limiting stainless steel resistor. Outgoing and return busbars are isolated from each other by use of multiple layers of mylar sheet, with sufficient overhang to meet the 2E+1 stand-off requirement. A 1mOhm overcurrent protection resistor is provided in case of short failure, clamping the maximum current to tolerable thresholds for the caps. The power supply should be properly insulated based on design. The rule of thumb to be followed is 2E+1, where E is the maximum system voltage. All bus work should be taken into consideration so that the inductance does not limit the system performance.

### 1.7 Charging

The charging supply will consist of two TDK-Lambda supplies, one 402L-10kV-POS-208VAC and one 402L-10kV-NEG-208VAC for each bank modules (so 6 in total, three sets in parallel). The charge supplies are

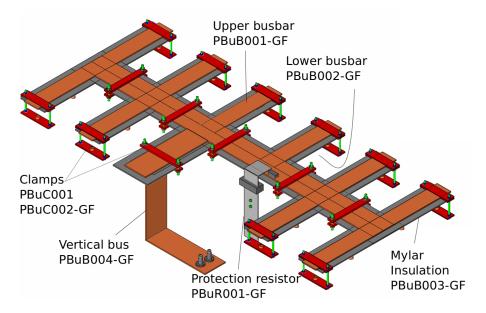


Figure 7: Buswork for GF bank.

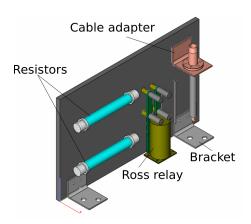


Figure 8: Charging switch and connection detail.

wired in series to create a ±10kV bipolar output. The two output lines each include a series resistor to improve regulation and limit output current under fault conditions. The lines are then split to run a cable to each capacitor module. At the capacitor module, the charge cable is connected across a diode that protects the charge supply in the event of a bank pre-fire (when the charge supply is connected to the bank). The diode prevents any bank reversal during pre-fire from imposing a reverse voltage at the charge supply. After the diode is a resistor that limits the charge current for the bank (and limits the protection diode current under reversal). The final connection to the capacitor busswork is made via a normally-open DPST Ross relay (E40-2PNO) which is only connected for charging, and is disconnected immediately prior to programmed discharge. Please refer to the separate specification for the charging supplies (treated as a separate sub-assembly). Charging cable is terminated at the bank with a custom connector, see Fig. 8.

### 1.8 Dump

Each capacitor module includes a resistor sized to dissipate the full-charge energy of the bank. The resistor material is an aqueous solution of copper sulfate with brass electrodes in a polycarbonate reservoir. The electrolyte concentration is tuned to discharge the bank to below 50 volts (the NFPA 70E safety threshold) within 30 seconds. This dump rate was chosen based upon a conservative estimate of the time required

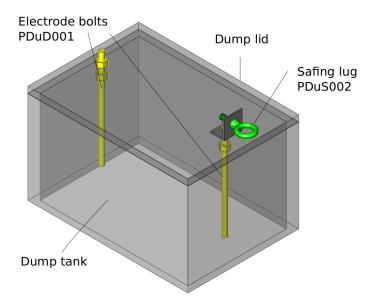


Figure 9: Dump detail for the GF bank module.

from removal of the Kirk key at the operator station to entry of the bank enclosure. The dump sizing is also designed to allow several sequential full-energy dumps at 3 minute intervals, but in this operation mode the resistor temperature shall be monitored remotely by the operator to ensure the temperature does not exceed 60°C (as per ASTM C1055) and that the water level is maintained. The normally-closed dump relay on each module (Ross E40-NC) will be energized only during charge, and will be de-energized to engage the dump upon removal of the Kirk key or at any emergency stop or interlock break. A temperature sensor is located on the outside lower section of each dump.

### 1.9 Harnessing

The harnessing sub-assembly comprises all of the interconnecting power cables from the CCDPS to the FLARE machine. The cabling will be triax of suitable current rating (see e.g. Dielectric Sciences specification in the Appendix). 5 cables will connect to the cable header located close to the switches and between the dumps. Cable trays will be used to route cables from the capacitor banks to the device.

### 1.10 Polarity switching

The GF coil current has been requested to have the ability to frequently and easily invert the direction of coil current. The CCDPS is fixed in its output polarity such that the cable center conductor is at positive voltage, the middle conductor layer carries the current return at negative voltage, and the outer shield of the cable provides an electrostatic ground. A concept has been developed to invert the current driven in the coil using a particular arrangement of busswork connections, as shown in Figure 10. Ideal placement of this switch would be at the coil interface to the experiment vessel. In the figure, one may consider the busswork at left to come from the cable header where cables from the CCDPS attach, and the busswork at right feeds to the coil interface. The blocks shown at center link the top bus at left to the rear bus at right, and the bottom at left to the front at right (top to rear, bottom to front). Coil polarity can be inverted simply by moving the bars to the other side horizontally (top to front, bottom to rear). Alternating sheets of mylar sheet insulation from the two sides must be interleaved between the connecting blocks to prevent arc flashover. Further engineering details cannot be defined until the coil header design is provided.

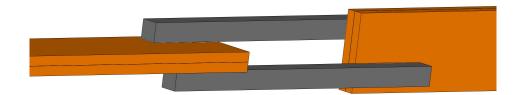


Figure 10: Concept for a simple, low inductance polarity switch. The blocks shown at center link the busswork at left to the busswork at right; moving the blocks to the unoccupied spaces (opposite sides of the busswork) effects a polarity switch. Insulation between the busswork is not shown.

### 1.11 Diagnostics

Diagnostics must be provided to measure the forward current in the bus leading to the forward switch (see gray block on safety resistor in Fig. 7 for placement), the voltage of the bank module using a voltage divider, and the temperature of the over-current protection resistor, the temperature in the dump resistor and the temperature at the anode of the ignitrons. Each of these diagnostic measurements must be transmitted along a fiber-optic connection to the DAQ. Please see separate DAQ specifications for further information.

### 1.12 Safety

Monitoring (analog and digital voltage monitoring) will be required. A voltage divider at the bank will be used to monitor the charging voltage on the control computer (see specification for DAQ), and provide a signal for a panel-mounted analog indicator at the entry to the enclosure. The GF bank modules will be housed in bays that separate them from other bank modules. Each side of the bank module may be separated by a 1/4 inch steel blast shield. The enclosure will be interlocked and procedures will be present to disable the bank before personnel access.

### 1.13 Cooling requirements

Ignitron switches in the GF modules require a connection to a water coolant supply to provide a minimum of 10 degrees of relative temperature difference between anode and cathode. Water coolant is provided by connection of 1/4" NPT fittings on the base of the ignitron to a water chiller. See detailed specifications in the appendix.

### 1.14 Connections

The connection schematic shows all of the connections that need to be made to the bank modules, power and control systems. From the left of Fig. 11, 208 and 110 power is fed to the bank enclosures via a Kirk key controlled isolation switch. This same switch can be energized by an Emergency Stop (E-stop) button located in the control room (this E-stop is digitized by both the FLARE control DAQ and the CCDPS control DAQ). If energized, the switch will drop all power to the enclosure, thereby killing power to the HV dump (normally closed) and charge (normally open) relays, and dumping bank energy into the cap dumps. The 110 and 208 power is delivered to the charging supply rack (located on it's own separate pallet), and 110 is also delivered to an isolation transformer mounted on the bank module pallet. Connections to the load are made by multiple triax cables (described above). Water is connected to the ignitron switches along 1/4" tubes from a shared chiller unit. The charge, dump ground relays are controlled by individual fiber-optic-enabled switches, with pulse signals sent from the CCDPS DAQ rack (Schematic shown in Fig. 12). Temperature sensor data are transmitted by fiber-optics from the pallet to the DAQ after conversion of voltage to frequency, then reconverting at the DAQ. A BNC connection is made from the current sensor integrator to the DAQ fast data acquisition (sampling at at least 1MHz). Timing synchronization is provided by the FLARE control DAQ. Switch firing is controlled here by the FLARE control computer and DAQ, by

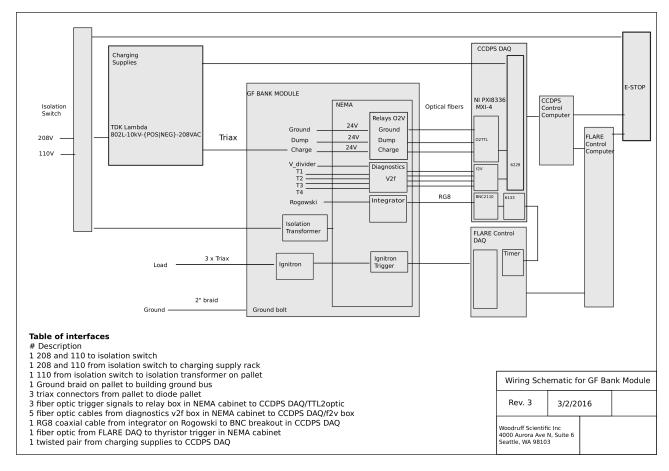


Figure 11: Connections

transmission of fire signal by fiber-optic connection. CCDPS DAQ requires 110V as input. CCDPS control computer requires 110V as input.

- Electrical input requirements: 208V three phase, 110V, less than 50 Amps (total for all banks at full charge is 100A)
- Load requirements: as specified in [1]
- Cooling requirements: chiller for ignitrons (see specification attached)
- Environmental requirements: dust free, see below
- Control signals needed as inputs: ESTOP and triggers (see Fig. 11)
- Control signals as outputs: none.

### 1.15 Environmental requirements

The entire CCDPS is specified to operate at room temperature, and will tolerate seasonal variations in humidity without the need for any special AC, other than cooling lines to the ignitrons. Ideally the banks will be placed in a dust-controlled environment (fans with filters, preferably with drywall to the ceiling), with minimal traffic to the enclosure.

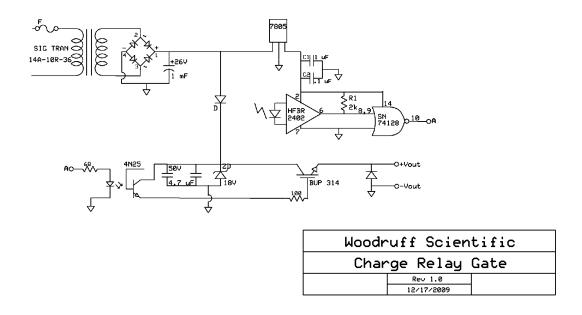


Figure 12: Schematic for charge, dump and ground relay control.

### 2 References

### References

[1] Statement of Work for Design of Capacitor Charge/Discharge Power Supply (CCDPS) for FLARE FLARE-CCDPS-150828, Revision 0, Sept. 9th 2015

### 3 Appendices

### 3.1 Engineering Drawings

	ОН	EF	$\mathrm{TF}$	PF
$\mathbf{H}$	8.125	8.125	6.25	6.75
W	10.875	10.875	15	15

Table 2: Bus Clamp Dimensions by Bank (inches)

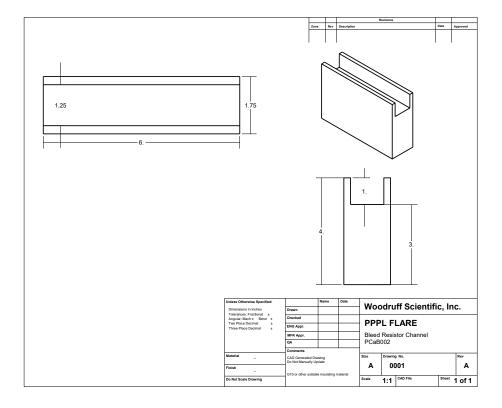


Figure 13: GF Bleed Resistor Channel

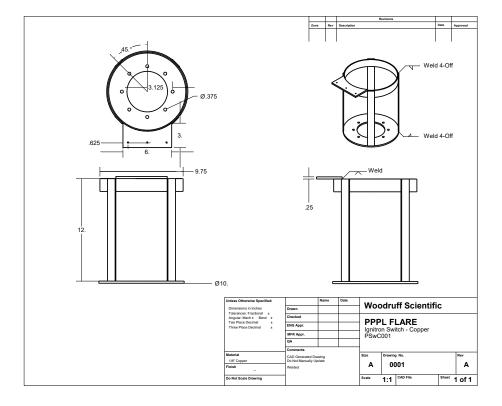


Figure 14: Ignitron Cage - Copper

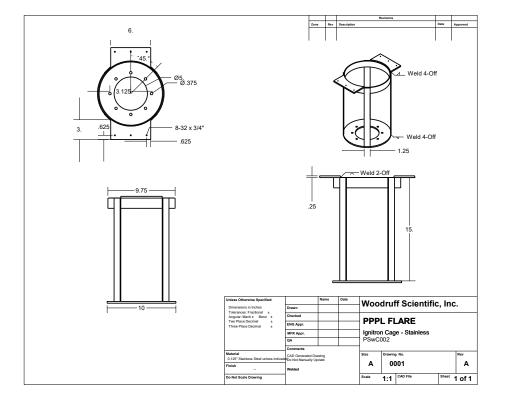


Figure 15: Ignitron Cage - Stainless

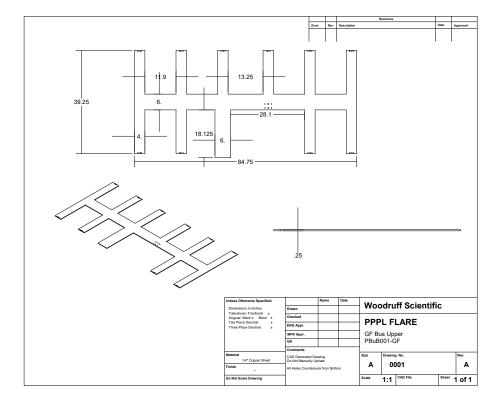


Figure 16: GF Bus Upper

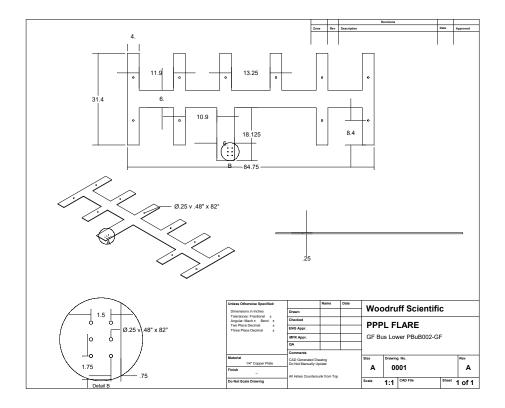


Figure 17: GF Bus Lower

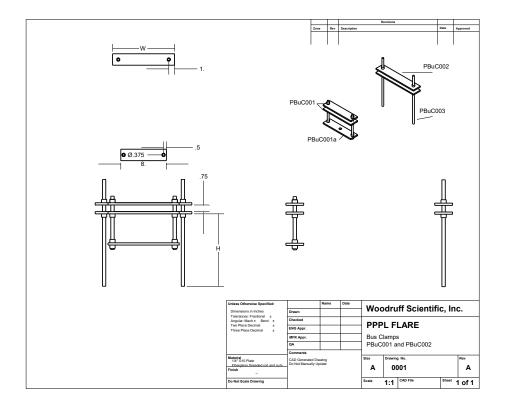


Figure 18: GF Bus Clamps

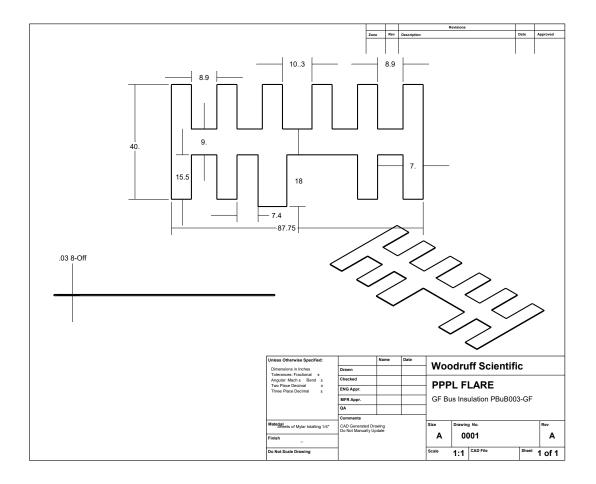


Figure 19: GF Bus Insulation

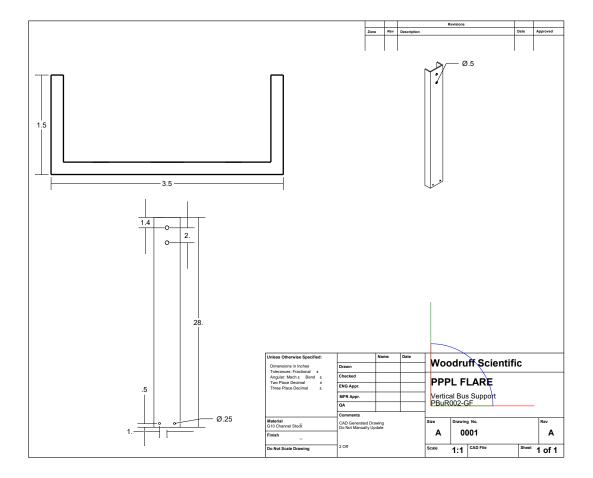


Figure 20: GF Bus Vertical Support

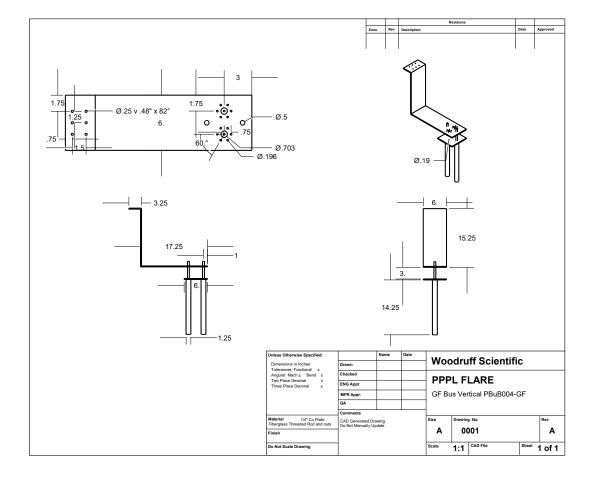


Figure 21: GF Bus Vertical

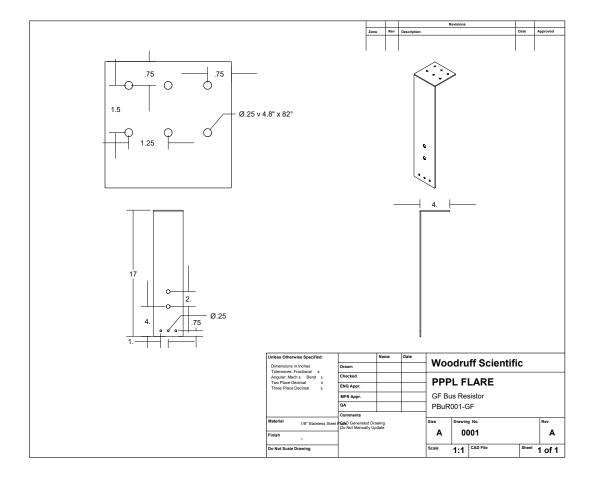


Figure 22: GF Bus Resistor

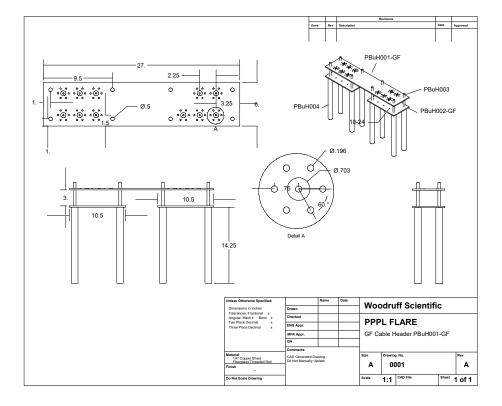


Figure 23: GF Cable Header

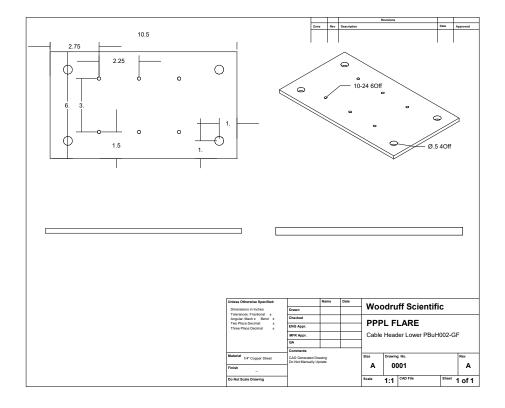


Figure 24: GF Cable Header Lower

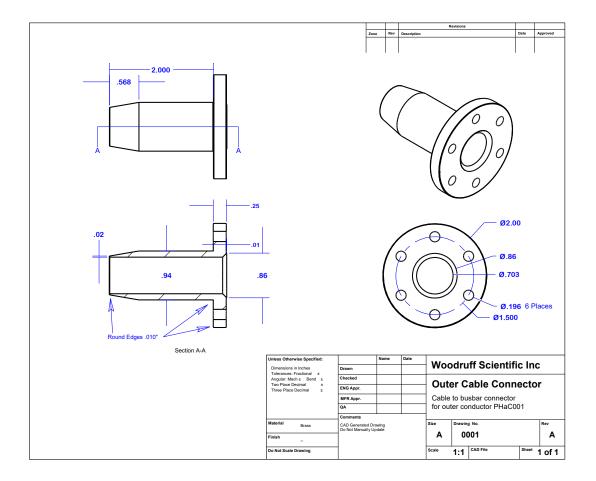


Figure 25: Outer Triax Connector

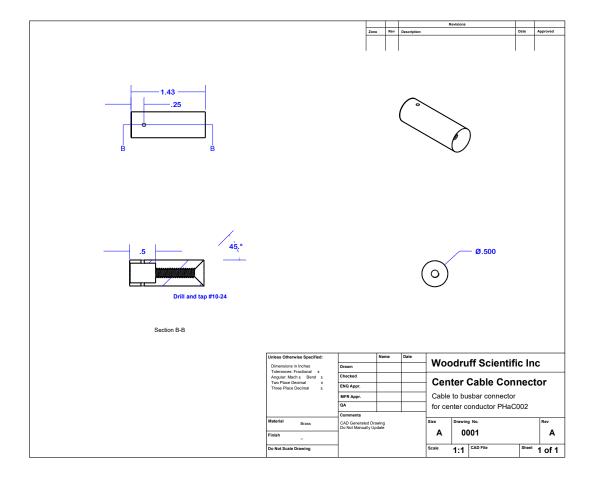


Figure 26: Inner Triax Connector

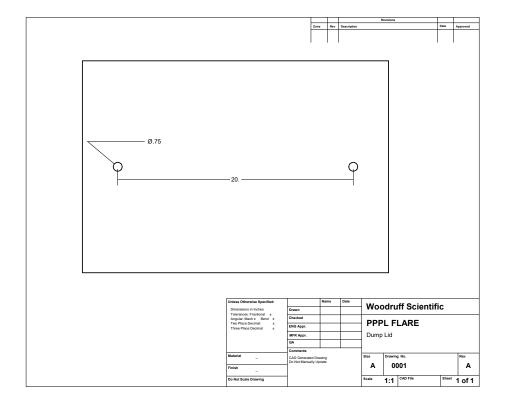


Figure 27: Dump Lid

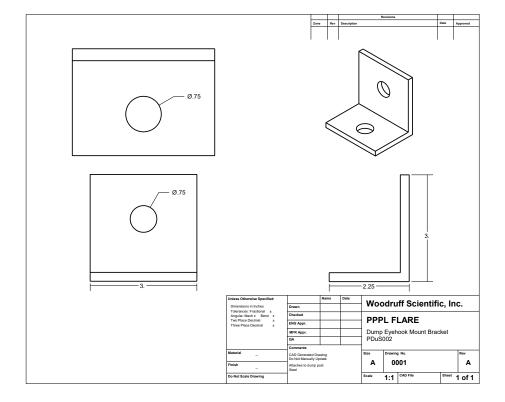


Figure 28: Dump Stick Eyehook Bracket



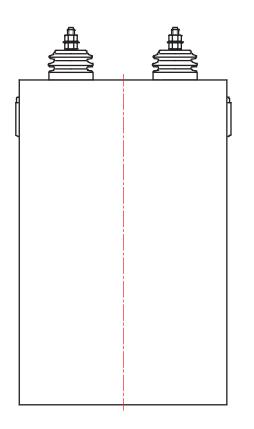
### HDCT 20kV 640 µF Pulse Capacitor

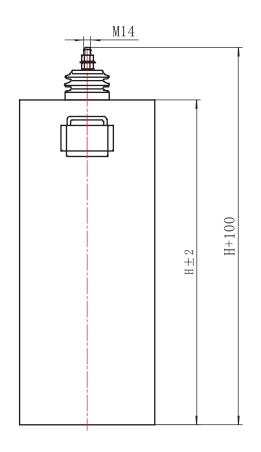
Туре		HDCT
Rated voltage	U <sub>NDC</sub>	20kVDC
Rated capacitance	$C_N$	640μF
Capacitance tolerance		±5.0%
Rated Discharge Current	$I_p$	5kA
Max Discharge Current (system fault)	Î	10kA
Rated Discharge Voltage Reversal	%	20%
Self inductance	L <sub>S</sub>	< 150 nH
Int. series resistance	R <sub>S</sub>	$<5 \mathrm{m}\Omega$
Loss factor	tanδ	$< 1.0 \times 10^{-3} / 100 \text{ Hz}$
Life Expectancy (90 % survival)		500,000 discharges
Operating temperature	Θmin/ max	-40°C / +70 °C
Technology		Metalized Polypropylene film, dry type, SH
Dimensions(mm <sup>3</sup> )		470×390×650

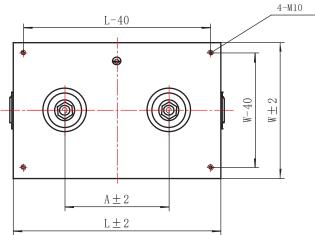




# NL640-20KVDC HIGH DENSITY CHARGE TRANSFER CAPACITOR







Specification	L (mm)	W (mm)	H (mm)	A (mm)
20kV 640 μ F	470	390	650	260



40W267 Keslinger Road PO Box 393, LaFox, IL 60147 USA 1.800.348.5580 (USA & Canada) 1.630.208.2200 (International)

www.rell.com | edg@rell.com



## **NL8900**

### **IGNITRON**

The NL8900 is a convection cooled ignitron for use as a high energy switch in capacitor discharge circuits. The NL8900 is capable of handling peak voltages of 35 kV and peak currents up to 300 kA.

### **GENERAL DATA**

### **Electrical:**

#### Mechanical:



Voltage	MIN	MAX	
Open Circuit (Ignitor +)	1000	35000	V
Inverse (Ignitor -)		5	V
Current, Short Circuit	500	2000	Α
Length of Firing Pulse,			
1/2 Sine Wave	5	10	μs

### **Thermal:**

Type of Cooling	Liquid	
Inlet Water Temperature (MIN)	10	°C
Inlet Water Temperature (MAX)	30	°C
Water Flow (At MAX Current)	3.0	GPM
Cathode Temperature (MAX)	35	°C
Anode Header Temperature (MAX)	55	°C
Ambient Temperature	10 to 30	°C
Anode to Cathode Temperature	(Note 1)	



July 09, Rev A



40W267 Keslinger Rd. PO Box 393, LaFox, IL USA 800-348-5580 (US & Canada) 630-208-2200 ▲ edg@rell.com

### **Maximum Ratings**

Dam	ped Disch	narge Ring	ing Disch	arge
Peak Anode Voltage				
Forward	35,000		35,000	V
Inverse	35,000		35,000	V
Critical Anode Starting Voltage (MIN)	100		100	V
Anode Current				
Peak	300,000		300,000	Α
Rate of Rise of Current	(Note 2)		(Note 2)	
Discharge (Rep Rate) Typical	2		2	Per Minute
Total Charge (Per Minute)	250		250	Coulombs
Ionization Time	0.5		0.5	μs
Voltage Reversal	None		100	%



### VARNING! USING SIMULTANEOUS MAXIMUM RATINGS WILL SEVERELY DETERIORATE IGNITRON LIFE!

#### Notes:

- 1) To prevent mercury condensation on the anode and anode seals, the anode header temperature should be 10°C higher than the cathode temperature at all times. Before operation, elevate the temperature of the anode area, with respect to the cathode, long enough to remove any mercury from the top portion of the ignitron.
- 2) Rate of rise depends upon the external circuitry.

### **Tube Life Considerations**

The method used to determine the life expectancy of an ignitron varies according to the application and it is necessary to consider the various types separately. It must be understood that the ratings specified are absolute limits. It is the responsibility of the equipment designer to ensure that the specified limits cannot be exceeded under the worse possible conditions of component tolerance, voltage fluctuation, and load variation.

A general rule of thumb: To obtain longer life, the ignitron must be operated at lower levels. Typically, life may be increased 10X if either the voltage or current is halved.

Ignitrons are robust high current switching devices. The current ratings may be exceeded to some extent without destroying the ignitron but with the consequence of reduced life.

### **IGNITOR**

The ignitor is a small rod of semiconducting material with a pointed end that is partially immersed into the cathode pool. When a suitable current pulse is passed through the ignitor-mercury junction (with the ignitor being positive with respect to the cathode pool) forms a cathode spot on the surface of the mercury and free electrons are emitted. If the anode is sufficiently positive with the cathode at this time, an arc will form between the cathode and anode. Once the arc is initiated, the ignitor has no further control and the ignitron continues to conduct until the voltage across the ignitron falls below the ionization potential of the mercury vapor.

In capacitor discharge circuits the ignitron has to pass a very high current and the conditions are naturally harmful to the ignitron. The mercury pool and the ignitor itself will become contaminated and the best life will be obtained if a high energy pulse is applied to the ignitor. Under these conditions a pulse from a separate excitation circuit containing a 1uf capacitor charged from 1500V to 3000V will provide 1 to 4.5 Joules of energy to the ignitor. Richardson Electronics endorses National Electronics Ignitrons using these parameters. Considering the wide range of ignitors available across the range of ignitrons produced, Richardson Electronics recommends that an ignitor pulse providing 4 to 7 Joules is optimal.

#### **MOUNTING**

The performance and life of the ignitron is greatly improved if it is operated in a field free space. Magnetic fields tend to force the arc toward the tube sidewall and aggravate sidewall arcing. Metal vapor produced by sidewall arcing is one of the major contributors to ignitor wetting. We recommend a coaxial type mounting to minimize field effects. See Page 5 for details.

### **INSTALLATION INFORMATION**

RECOMMENDED CONDITIONING BEFORE INITIAL USE - The ignitron is in high voltage operating condition before leaving the factory. Shipping tends to redistribute mercury throughout the ignitron making certain conditioning steps desirable before installation.

Heat Conditioning - Before applying voltage, heat anode stud to 100-125°C (keeping cathode near room temperature) for two hours minimum. This drives mercury away from anode and anode seal area.

Voltage Conditioning (after Heat Conditioning) - Apply 110% of operating voltage (preferably DCV) or up to 110% of rated maximum voltage across ignitron (anode positive and ignitor not connected) with a series combination of a 1 to 4 uf capacitor and a 1 ohm resistor in parallel with the ignitron. NATIONAL will replace any ignitron that will not hold off minimum voltage at initial test when caused by a manufacturing defect. Additional conditioning at higher voltages is recommended to stabilize the ignitron after shipping. Slowly increase voltage above minimum. Breakdown may occur but the ignitron will attain a Hi-Pot Stabilization Voltage of approximately 125% of operating voltage, or up to 125% of rated maximum voltage.

NOTE: The time required for conditioning to Hi-Pot Stabilization Voltage can be reduced by using a variable ac voltage source connected directly across the ignitron (ignitor not connected). Slowly increase the voltage; limit the current to 30 milliamperes maximum.

RECOMMENDED PRACTICE AFTER INITIAL USE - Mercury condensed in the anode and anode seal area greatly decreases the ignitron's voltage hold-off ability. Heat conditioning before initial use complements proper mercury distribution before the ignitron is first placed in operation. Once in operation, maintain a thermal gradient so that the anode area is at least 10°C greater than the cathode. This is also true during any cooling period. The anode and anode area must not cool faster than the cathode.

The ignitor becomes susceptible to damage by movement of mercury after use in a capacitor discharge or crowbar application. For maximum life, we recommend that an ignitron not be moved until end-of-life once it has been placed in service.

### LIFE AND WARRANTY

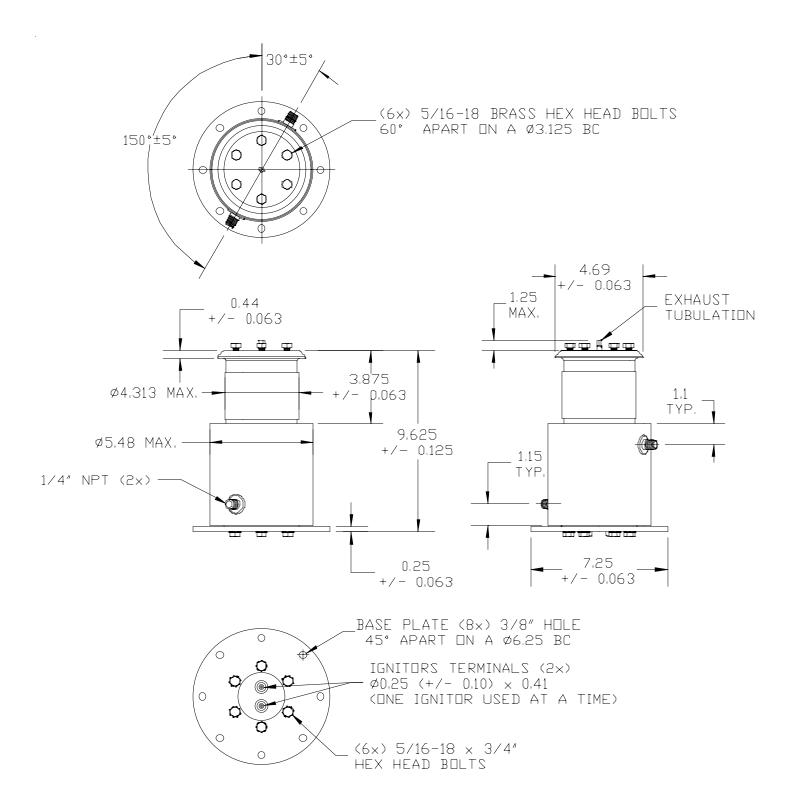
Richardson Electronics, Ltd. warrants the tube types listed above to be free from defects of design, material, and work-manship when received and, after receiving Recommended Conditioning Before Initial Use, to operate satisfactorily when first installed and, if used within ratings, to give a minimum of 1000 operations. No adjustment will be made if the tube is not placed in service within six months after date of shipment by manufacturer. This warranty expires 12 months after date of shipment by manufacturer.

National High Voltage Switching Ignitrons have an expected life of many times the warranted number of operations in most applications. Operating within the recommended ratings and following the *Recommended Practices After Initial Use* will greatly increase the life or operations obtained.

### **AVAILABLE ACCESSORIES**

Part Number	Description
1K958-Series	Ignitor Tulip Clip/Cable Assembly (Various options available, check with your local Richardson representative for details.)
IG5F2-10	Ignitor Trigger Module (Works on all National Ignitrons.)

#### **OUTLINE DRAWING**



NOTE: The mounting flange attached to the bottom of the tube can be modified in most cases for compatibility with the users socket. In all cases coaxial returns "squirrel cages" are recommended. The anode contact must NOT be ridged with respect to the cathode and the flexible anode connection MUST absorb all buss bar movement.



# IG5F2-10 Ignitron Driver Manual

Serial Number	
Test V open	
Test I short w/protection:	
Test I short w/o protection:	
Life Test Start	
Life Test Finish	



Phone 800-348-5580 FAX 630-208-2553

### 1. General

The IG5F2-10 Ignitron driver is designed to meet the specifications for triggering all ignitrons. It also provides a trigger isolation capability of 25 kV. It's specifications are:

Stored Energy: 4 Joule at 1.0 Hz.; 3 J at 2 Hz.

Open Circuit Voltage: 1.80 kV at 1.0 Hz.

Current: 370 A output into typical ignitron ignitor (1 Hz.)

AC Input Voltage: 100 - 125 VAC input or 200 - 250 VAC input using internal slide

switch. Failure to set the unit properly when using the higher

voltage will destroy the unit.

Input Pulse: 5 V TTL if fiber optic transmitter accessory board is used

Note that most 5 - 10 mA sources will drive this with 3 m cable.

Input Pulse Duration: 3 - 100 usec

Output Voltage Isolation: 25 kV to the input voltage

Fuse: 1/4 A internal

Supplied Fiber: 10 m. standard HP Versatile Fiber Type

Trigger Delay: 1200 ns. Typical

Status Indicators: TRIG TEST (See figures for TRIG TEST output characteristics)

PS STATUS

Storage Temperature: -20 C - 45 C

Operating Temperature 5C - 40 C

### 2.0 Installation

Connect a versatile fiber trigger signal to the input fiber optic. The BNC/fiber adapter may be used to supply the trigger to the unit by applying a 5 - 15 V pulse to the BNC. TTL signals which meet typical TTL requirements will trigger the unit (5 V, 5 mA).

Connect the output marked "Ignitor" to the Ignitor pin, and connect the output marked "Cathode" to the cathode. These connections should be secure and capable of conducting 400 A pulsed.

Open the unit and check the internal switch to assure that the power is set to the type of power line you plan to use. **If the internal power switch is not set correctly the unit may fail.** The factory setting is always for 220 VAC. Connect the input power (220 VAC nominal or 110 VAC nominal) to the AC receptacle once the settings of both switches are assured. If a powered trigger module has been supplied, check the settings of that unit before use.

Pulse the unit. Check the connections without HV applied to the ignitron to make sure that the contacts are not arcing. The unit will make an audible "ticking" noise when triggered.

### 3.0 Mounting

A template for mounting the unit is appended. Study used are Metric system M8.

### 4.0 Applications

The IG5-F is an ignitron driver supplied with the capability for isolation of the output. For circuits where the cathode is floating, such as series ignitron applications, the circuit can derive power from the external circuit:

### Circuit A Recomended Wherever Possible

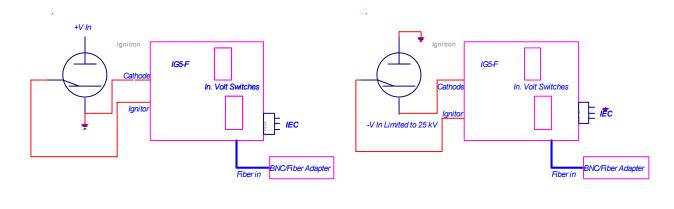
In circuit A, the cathode of the ignitron is grounded. If this circuit can be used, cooling of the ignitron jacket is simplified, along with triggering and monitoring. The unit power is connected to line voltage, the fiber is inserted into the driver, and the unit triggers with each light pulse. The input power ground should be grounded (IEC plug and chassis ground).

### Circuit B Lower Value Biases

In circuit B, the cathode of the ignitron is at some potential up to 25 kV from ground. If this circuit can be used, heating of the anode insulator is simplified, along with triggering and monitoring. The unit power is connected to line voltage, the fiber is inserted into the driver, and the unit triggers with each light pulse. An MOV of appropriate voltage connected from either of the line voltages (preferably neutral if such exists) to the preferred earth ground may be desirable. No voltage can exceed 25 kV relative to ground. The input power ground should be grounded (IEC plug and chassis ground).

### Circuit C Floating Ignitron Powered by AC

In circuit C the circuit derives it's power from AC voltage, but neither the cathode or anode is grounded. The voltage difference between the cathode/ignitor and anode must not excede 25 kV including during transients. No voltage can exceed 25 kV relative to ground.



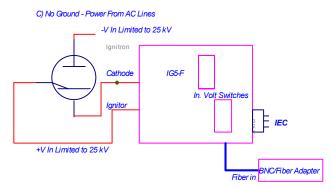


Figure 1 Application scenarios. The metal box should always be grounded.

### 5.0 Mounting

All parts are mounted to the enclosure. In order to mount the box, drill holes as described in the appended print, or use the template supplied.

### 6.0 Grounding

The box is designed for grounded operation. If floating operation is neccessary, the signal source and power source must be floated to the same potential. The difference between the power voltage and the box voltage should not exceed 700 V peak.

### 7.0 Power Supply Voltage Monitor

The monitor labeled PS Status has an output when the power supply driving the SCR is "ready". This will fail to light if the 600 V internal power supply or SCR fails.

### Figure of TRIG TEST output characteristic

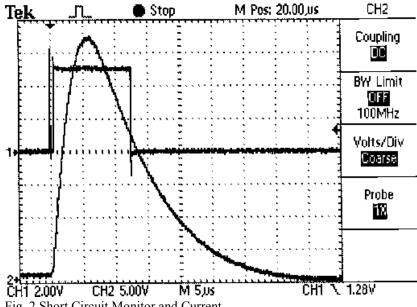


Fig. 2 Short Circuit Monitor and Current.

Figure 2 shows the current in the output along with the monitor output for the case where the ignitron ignitor fires immediately. The montor is on for 10 - 15 microseconds and it's main pulse starts within 2 microseconds of trigger initiation. This corresponds to nominally good performance.

Figure 3 shows the open circuit/open ignitor case. A pulse after saturation of the transformer, delayed by approximately 5 microseconds. In most situations, the pulse should appear in 4 microseconds or less time after initition of the pulse from the fiber.

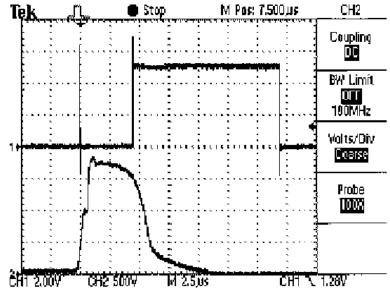


Fig. 3 monitor and open circuit voltage

### **SPECIFICATIONS IG5F2-10**

The IG5F2-10 Ignitron driver is designed to meet the specifications for triggering all ignitrons. It also provides a trigger isolation capability of 25 kV. It's specifications are:

Stored Energy: 4 Joule at 1.0 Hz.; 3 J at 2 Hz.

Open Circuit Voltage: 1.80 kV at 1.0 Hz.

Current: 370 A output into typical ignitron ignitor (1 Hz.)

AC Input Voltage: 100 - 125 VAC input or 200 - 250 VAC input using internal slide

switch. Failure to set the unit properly when using the higher

voltage will destroy the unit.

Input Pulse: 5 V TTL if fiber optic transmitter accessory board is used

Note that most 10 mA sources will drive this with 3 m cable.

Longer cables will require more current

Input Pulse Duration: 3 - 100 usec

Output Voltage Isolation: 25 kV to the input voltage

Fuse: 1/8 A internal - 220 VAC; 1/4A internal 110 VAC

Supplied Fiber: 10 m. standard HP Versatile Fiber Type

Trigger Delay: 1200 ns. Typical

Status Indicators: TRIG TEST (See figures for TRIG TEST output characteristics)

PS STATUS

### NOTES:

### IG-5-F-T2 Ignitron/Thyratron Driver Multiple Trigger Output Accessory

The IG-5-F-T4 is a 2 output trigger driver for North Star Ignitron and Thyratron drivers. It consists of a BNC high impedance input, a pulse amplifier, and 4 trigger output channels. The specifications are:

Power Supply Input Voltage: 100 - 260 V

(Note: Power Supply is CE marked)

Input Power Connection Standard IEC320 as used on most computers

Input Voltage: 2.4 V "on" 0.8 V "off"

Input Voltage: 15 V max Input Current: 10 uA

Input Pulse Duration: 100 ns. Minimum

Output Pulse Power 5 dbm Output Power Risetime Max. 85 ns.

Output Pulse Duration Input pulse duration- 30 ns. min

Output Delay Time 75 ns. typical Output Power Peak Wavelength 650 nm.

**Output Fiber Specification** 

Type: Plastic Diameter 1 mm

Brand Hewlett Packard

Part Number HP 3510 Simplex or HP 3610 Duplex

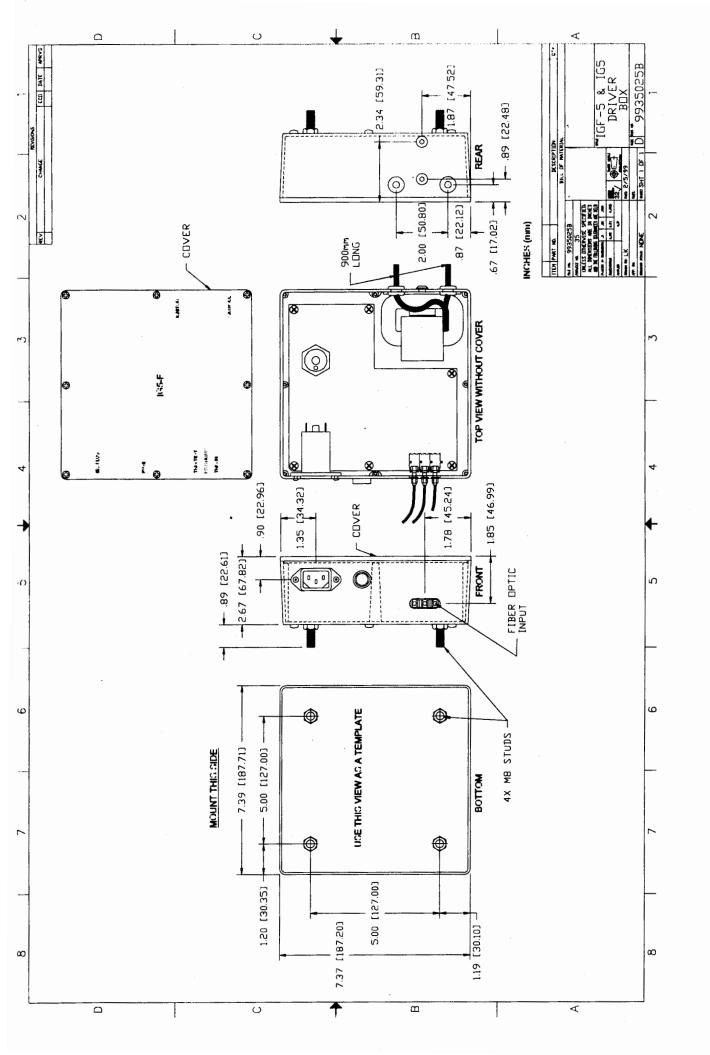
Notes on cable: **Do not bend Fiber Optic Cable with a radius of** 

curvature of less than 4 cm. The light signal drops

significantly for tight bends.

### **Application**

The unit is designed to simultaneously trigger multiple ignitrons or thyratrons. The unit should be connected to a TTL or higher input voltage (15 V Max.). It produces an output pulse of the same duration.



4000 V  $V_{RSM}$ 

 $I_{F(AV)M} =$ 5200 A

 $I_{F(RMS)} =$ 8200 A

 $85 \times 10^{3} A$ I<sub>FSM</sub>

0.8 V  $V_{F0}$ 

 $0.086 \text{ m}\Omega$ 

### **Rectifier Diode** 5SDD 54N4000

Doc. No. 5SYA1171-00 Dec. 03

- Patented free-floating silicon technology
- Very low on-state losses
- Optimum power handling capability

### **Blocking**

Maximum rated values 1)

Parameter	Symbol	Conditions	Value	Unit
Repetitive peak reverse voltage	$V_{RRM}$	$f = 50 \text{ Hz}, t_p = 10 \text{ms}, T_j = 0150 ^{\circ}\text{C}$	3600	V
Non - repetitive peak reverse voltage	$V_{RSM}$	$f = 5 \text{ Hz}, t_p = 10 \text{ms}, T_j = 0150 ^{\circ}\text{C}$	4000	V

### Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. (reverse) leakage current	I <sub>RRM</sub>	V <sub>RRM</sub> , Tj = 150°C			400	mΑ

### **Mechanical data**

Maximum rated values 1)

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	F <sub>M</sub>		81	90	108	kN
Acceleration	а	Device unclamped			50	m/s <sup>2</sup>
Acceleration	а	Device clamped			100	m/s <sup>2</sup>

### Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Weight	m				2.8	kg
Housing thickness	Н	$F_M = 90 \text{ kN}, T_a = 25 ^{\circ}\text{C}$			35.9	mm
Surface creepage distance	Ds		56			mm
Air strike distance	Da		22			mm

<sup>1)</sup> Maximum rated values indicate limits beyond which damage to the device may occur

ABB Switzerland Ltd, Semiconductors reserves the right to change specifications without notice.



### **On-state**

### Maximum rated values 1)

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. average on-state current	I <sub>F(AV)M</sub>	50 Hz, Half sine wave, T <sub>C</sub> = 85 °C			5200	Α
Max. RMS on-state current	I <sub>F(RMS)</sub>				8200	Α
Max. peak non-repetitive surge current	I <sub>FSM</sub>	$t_p = 10 \text{ ms}, T_j = 150^{\circ}\text{C}, \ V_R = 0 \text{ V}$			85×10 <sup>3</sup>	Α
Limiting load integral	l <sup>2</sup> t				36.3×10 <sup>6</sup>	A <sup>2</sup> s
Max. peak non-repetitive surge current	I <sub>FSM</sub>	$t_p = 8.3 \text{ ms}, T_j = 150^{\circ}\text{C}, \ V_R = 0 \text{ V}$			90×10 <sup>3</sup>	Α
Limiting load integral	l <sup>2</sup> t				34.6×10 <sup>6</sup>	A <sup>2</sup> s

### Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	$V_{F}$	$I_F = 5000 \text{ A}, T_j = 150^{\circ}\text{C}$			1.23	V
Threshold voltage	V <sub>(T0)</sub>	T <sub>j</sub> = 150°C			8.0	V
Slope resistance	r <sub>T</sub>	I <sub>T</sub> = 25007500 A			0.086	mΩ

### **Switching**

### Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Recovery charge		$d_{i_F}/dt = -10 \text{ A/}\mu\text{s}, \ V_R = 200 \text{ V} \\ I_{FRM} = 4000 \text{ A}, \ T_j = 150^{\circ}\text{C}$			18000	μAs

### **Thermal**

### Maximum rated values 1)

Parameter	Symbol	Conditions	min	typ	max	Unit
Operating junction temperature range	$T_{vj}$		0		150	ů
Storage temperature range	T <sub>stg</sub>		-40		150	°C

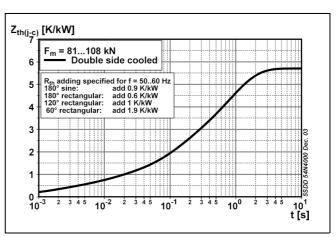
Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case $R_{\text{th(j-c)}}$		Double-side cooled F <sub>m</sub> = 81108 kN			5.7	K/kW
	$R_{th(j-c)A}$	Anode-side cooled F <sub>m</sub> = 81108 kN			11.4	K/kW
	$R_{th(j-c)C}$	Cathode-side cooled F <sub>m</sub> = 81108 kN			11.4	K/kW
Thermal resistance case to heatsink	R <sub>th(c-h)</sub>	Double-side cooled F <sub>m</sub> = 81108 kN			1	K/kW
	R <sub>th(c-h)</sub>	Single-side cooled F <sub>m</sub> = 81108 kN			2	K/kW

### Analytical function for transient thermal impedance:

$$Z_{th(j-c)}(t) = \sum_{i=1}^{n} R_{th i} (1 - e^{-t/\tau_i})$$

i	1	2	3	4
$R_{th i}(K/kW)$	3.728	1.248	0.433	0.292
$\tau_i(s)$	τ <sub>i</sub> (s) 0.8115		0.0089	0.0015



**Fig. 1** Transient thermal impedance junction-to-case.

### Max. on-state characteristic model: $V_{F25} = A_{Tvj} + B_{Tvj} \cdot I_F + C_{Tvj} \cdot \ln(I_F + 1) + D_{Tvj} \cdot \sqrt{I_F}$ Valid for $I_F = 300 - 110000 A$ $B_{25}$ C<sub>25</sub> $D_{25}$ $A_{25}$ 486.40×10<sup>-3</sup> 45.53×10<sup>-6</sup> 65.82×10<sup>-3</sup> 68.19×10<sup>-15</sup> T<sub>vj</sub> = 25 °C Max. V<sub>F25</sub> $T_{vj} = 150 \, ^{\circ}\text{C}$ Max. $V_{F150}$ 12 10 8 6

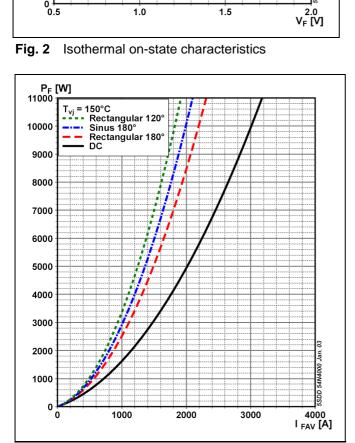


Fig. 4 On-state power losses vs average on-state current.

### 

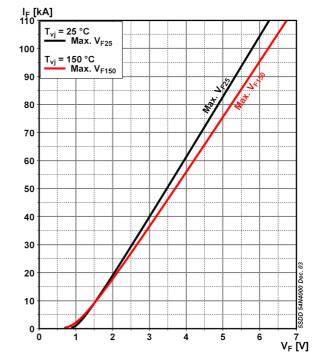
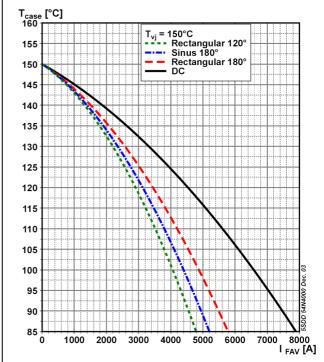
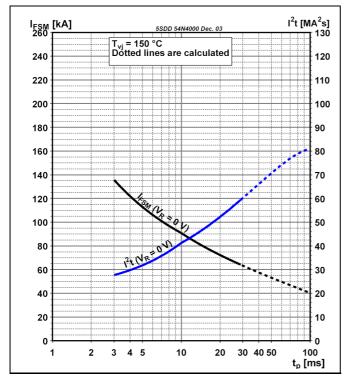


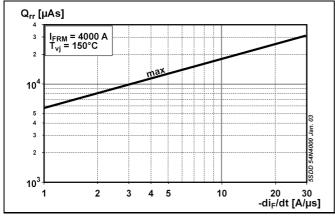
Fig. 3 Isothermal on-state characteristics



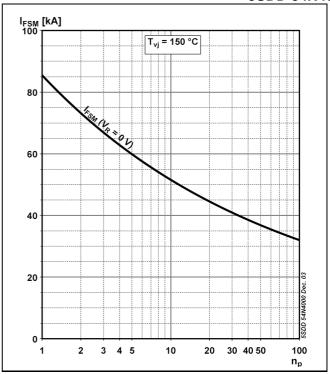
**Fig. 5** Max. permissible case temperature vs average on-state current.



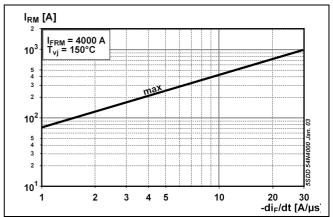
**Fig. 6** Surge on-state current vs. pulse length. Half-sine wave.



**Fig. 8** Recovery charge vs. decay rate of on-state current.



**Fig. 7** Surge on-state current vs. number of pulses. Half-sine wave, 10 ms, 50Hz.



**Fig. 9** Peak reverse recovery current vs. decay rate of on-state current.

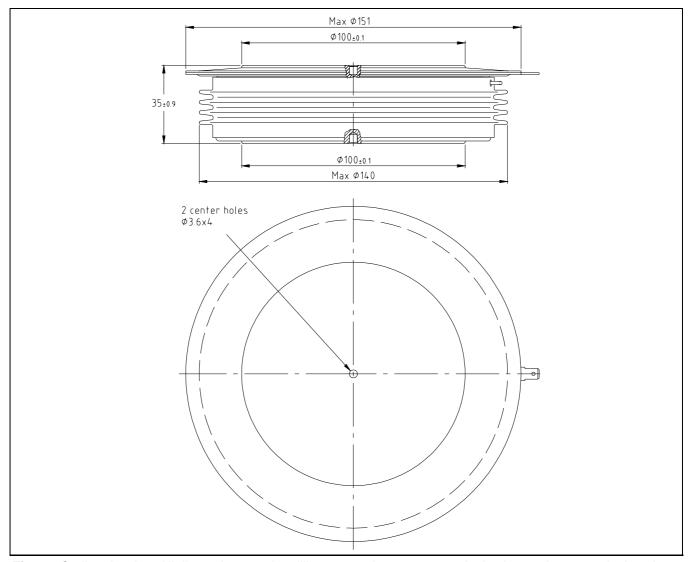


Fig. 10 Outline drawing. All dimensions are in millimeters and represent nominal values unless stated otherwise.

### Related application notes:

Doc. Nr	Titel				
5SYA 2020	Design of RC-Snubbers for Phase Control Applications				
5SYA 2029	Designing Large Rectifiers with High Power Diodes				
5SYA 2036	5SYA 2036 Recommendations regarding mechanical clamping of Press Pack High Power Semiconductors				
Please refer t	to http://www.abb.com/semiconductors for actual versions.				

ABB Switzerland Ltd, Semiconductors reserves the right to change specifications without notice.



ABB Switzerland Ltd Semiconductors

Fabrikstrasse 3 CH-5600 Lenzburg, Switzerland

Telephone +41 (0)58 586 1419 Fax +41 (0)58 586 1306 Email abbsem@ch.abb.com

Internet www.abb.com/semiconductors

Doc. No. 5SYA1171-00 Dec. 03



# 402 Series Data Sheet High Voltage Power Supply Capacitor Charging and DC Output Voltage from 1kV - 50kV Output Power 4kJ/sec or 4kW

Full local and remote control



### TDK·Lambda

www.us.tdk-lambda.com/hp

### 402 Series Specification

Industry standard rack mount capacitor charging and DC power supplies with 4kJ/sec rating for capacitor charging, or 4kW rating in continuous DC applications.

- Power rating of 4kJ/sec, 5kJ/sec peak
- Output Voltages from 0-1kV to 0-50kV
- Compact air cooled rack mount package
- Efficient IGBT based resonant inverter
- Excellent pulse to pulse repeatability
- 208 or 400VAC 3Ø input voltage
- Comprehensive remote control interface
- **UL Approved AC line contactor (optional for OEM models)**
- Ultra reliable and rugged industry standard design
- Passive PFC (pf = 0.85)
- Full local output voltage and HV On/Off controls (L version)
- Simple parallel operation for higher power
- Lab, Slave, or OEM front panel options

Average Capacitor Charging Power	4,000 Joules/sec (½CV² x Rep Rate)			
Peak Capacitor Charging Power	5,000 Joules/sec (½CV²/t <sub>charge</sub> )			
Average Continuous DC Power	4,000 Watts			
Output Voltage Range	1, 2, 4, 5, 10, 15, 20, 30, 40, 50kV, variable from 10-100% of rated			
Polarity	Available as fixed Positive or Negative. Please specify at time of ordering			
HV Output Cable	1-39kV Models - DS2124 Coaxial cable with proprietary HV connector			
	40-50kV Models - DS2214 Coaxial cable with proprietary HV connector			
HV Insulating Medium	Exxon Mobil Univolt N61B or equivalent insulating oil			
AC Input Voltage	208VAC (180-264), 3Ø or 400VAC (340-460), 3Ø + N, specify at time of ordering			
AC Input Current	20A/15A			
AC Connector	UL/CSA approved terminal block. 3Ø + ± for 208VAC, 3Ø + N + ± for 400VAC			
AC Line Contactor	UL/CSA approved AC line contactor (standard on 402L and 402S, option for 402OEM)			
Power Factor	Passive PFC pf = 0.85 at full load and nominal AC line			
Efficiency	Better than 85% at full load			
Front Panel	402L - Voltage Control, Voltage & Current Meters, Status Indicators			
	402S - On/Off Switch, Status Indicators			
	402-OEM - Blank front panel			
Stability	0.2% per hour after 1 hour warmup			
Temperature Coefficient	100ppm per °C typical			
Stored Energy	Less than 0.3J all models			
Pulse to Pulse Repeatability	±2% to 1000Hz, consult factory for higher rep rates			
Dimensions - inches (mm)	19 (483) W x 7 (178) H x 17 (432) D			
Weight - lbs (kg)	65 (30)			
Ambient Temperature	Storage: -40 to +85°C. Operating: -20 to +45°C			
Altitude	Storage: 40,000ft (12,000m), Operating: 9,900ft (3,000m)			
Humidity	10-90%, non-condensing			
Protection	Open/short circuits, Overloads, Arcs, Overtemp, Overvoltage, Safety Interlock			
Remote Control (all models)	Via 25-pin D-sub connector on rear of unit, Signals include, Vprogram (0-10V), HV Enable/Reset, Inhibit, Summary Fault, Load Fault, Vanalog, Vpeak			
Accessories	10ft HV cable, operating manual			
Options	EN - Low Enable. Replaces standard high enable			
	5V - 0-5V Analog programming. Replaces standard 0-10V programming.			
	LP - Latching Overload Protection, requires HV reset after overload fault			
	DC - Continuous DC operation			
	CT - AC line contactor (option for 402OEM models only, standard on 402L and 402S)			
	Double terminated HV cable, and mating bulkhead connector			
Ordering Info	Model - XXkV - POS (or NEG) - YYYVAC - ZZ (options)			
Ordering Examples	402L-10kV-POS, 402S-1kV-NEG-DC, 402-OEM-50kV-POS-400VAC			
All specifications subject to change withou	·			

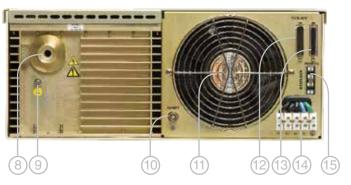
### 402 Series Mechanical Details

### **402L Front View**

## MODEL 402L

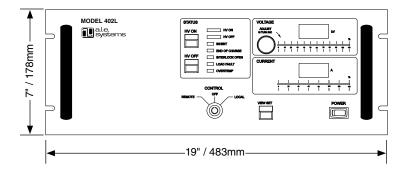
- 1 HV On/Off Push Buttons (L model only)
- 2 Status Indicator LEDs (L and S models only)
- 3 Local/Remote Keyswitch (L model only)
- 4 10-Turn HV Output Control (L models only)
- 5 View Set Push Button (L models only)
- 6 Output Voltage and Current Displays (L models only)
- 7 Power Switch (L and S models only)

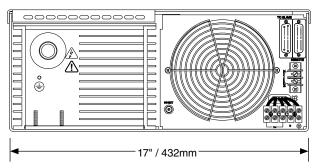
### 402L Rear View

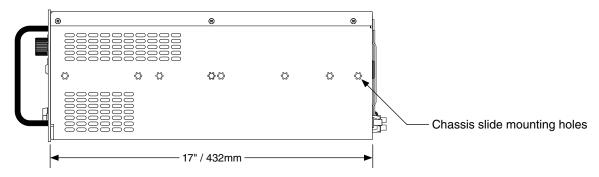


- 8 HV Output Connector
- 9 Ground Stud
- 10 Inhibit BNC (L models only)
- 11 Cooling Fan
- 12 Slave Supply Programming Connector (L models only)
- 13 Remote Programming Connector
- 14 AC Input Terminal Block
- 15 Interlock Terminals (L and S models only)

### **Outline Drawings**







- 1 Chassis slide mounting pattern matches General Devices CT series or equivalent with 3.875" hole spacing.
- 2 Cooling air enters rear of unit and exits at either side. Do not block air vents or cooling fan and allow several inches of clearance at rear of unit.
- 3 Allow 6" bend radius at rear of unit for HV cable.

### GLOBAL HIGH VOLTAGE NETWORK

### NORTH AMERICA

TDK-Lambda Americas Inc., High Power Division

405 Essex Rd. Neptune, NJ 07753

Tel: +1-732-922-9300, Fax: +1-732-922-1441 E-mail: andy.tydeman@us.tdk-lambda.com

Web: www.us.tdk-lambda.com/hp

### CANADA

**TMetrix** 

5805 Kennedy Road Mississauga,

Ontario L4Z 2G3

Tel: +1-905-890-2010, Fax: +1-905-890-1959 E-mail: lambda@aca.ca, Web: tmetrix.com

UK

**IRELAND** 

Pulse Power & Measurement Ltd. 65 Shrivenham Hundred Business Park Watchfield, Swindon Wiltshire, SN6 8TY

Tel: +44-1793-784389, Fax: +44-1793-784391 Email: sales@ppm.co.uk, Web: www.ppmpower.co.uk

FRANCE

BELGIUM

SPAIN

**NETHERLANDS** 

LUXEMBOURG

TDK-Lambda France

ZAC des Delaches CS 41077, 9 rue Thuillere

91978 Villebon Courtaboeuf

Tel: +33 1 60 12 71 65, Fax: +33 1 60 12 71 66

Email: france@fr.tdk-lambda.com Web: www.fr.tdk-lambda.com

GERMANY

AUSTRIA

SWITZERLAND

Guth GmbH Spitzenbergstrasse 6

D - 73084 Salach

Tel: +49-7162-948930, Fax: +49-7162-9489399 Email: kontakt@guth-hv.de, Web: www.guth-hv.de

**ITALY** 

TDK-Lambda Italy

Via dei Lavoratori 128/130

IT 20092 Cinisello Balsamo (MI)

Tel: +39-02-6129-3863. Fax: +39-02-6129-0900

Email: info.italia@it.tdk-lambda.com Web: www.it.tdk-lambda.com

SCANDINAVIA

**BALTICS** 

Divisoft AB

Rallarvägen 41, SE-184 40 Åkersberga, Sweden Tel: +46 8 540 248 09, Fax: +46 8 501 096 53 Email: iain@divisoft.se, Web: www.divisoft.se

ISRAEL

RUSSIA

UKRAINE

TDK-Lambda Israel Ltd.

Kibbutz Givat Hashlosha Tel-Aviv 48800 Tel: +972-3-9024-333, Fax: +972-3-9024-777

Email: info@tdk-lambda.co.il, Web: www.tdk-lambda.co.il

**BRAZIL** 

Suplitec

Rua Sena Madureira 455, Belo Hte - 31340-000 Tel: +55-31-3498 1177, Fax: +55-31-3441 0841

Email: vendas@suplitec.com.br, Web: www.suplitec.com.br

MEXICO

AcMax De Mexico

Rosas 139 Col. Bugambilias. Puebla, Pue. C.P. 72580

Tel: +52-800-211-0060, Fax: +52-264-1445 Email: edaena@acmax.mx, Web: www.acmax.mx

JAPAN

KOREA

Electronics Optics Research, Ltd 4-26-19 Koenji-Minami Suginami-ku, Tokyo 166-0003

Tel: +81-333-145699, Fax: +81-333-142333 Email: imamura@eor.jp, Web: www.eor.jp

**CHINA** 

TDK-Lambda Shanghai Office

2nd Floor of Building No.1, No.15 Guiging Road,

Shanghai, 200233 P.R. China

Tel: +86-21-64850777, Fax: +86-21-64850666

Email:sales-sh@cn.tdk-lambda.com Web: www.cn.tdk-lambda.com

MALAYSIA

TDK-Lambda Malaysia

No.7.3, 7th Floor, Jaya Shopping Center,

Jalan Semangat Section 14, 46100

Petaling Java Selangor, D.E.

Tel: +60-3-7957-8800 Fax: +60-3-7958-2400

Web: www.tdk-lambda.com.my

SINGAPORE

**PHILIPPINES** 

**THAILAND** 

TDK-Lambda Singapore 1008 Toa Payoh North # 06-01/08

Singapore 318996

Tel: +65-6251-7211 Fax: +65-6250-9171

Web: www.se.tdk-lambda.com

INDIA

TDK-Lambda India

#526, Ground Floor, 10th Main, 7th Cross,

Jeevanbhimanagar, Bangalore 560 075, Karnataka, India

Tel: +91-80-43550500, Fax: +91-80-43550501 Email: mathew.philip@in.tdk-lambda.com

Web www.in.tdk-lambda.com

**SOUTH AFRICA** 

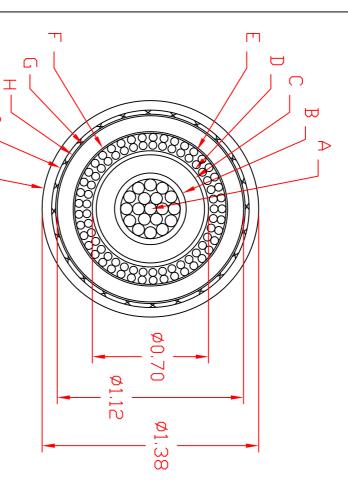
PaR Systems (Pty) Ltd. Pretoria, South Africa

Tel: +27-12-5480370, Fax: +27-12-5480447

Email: ndupreez@par.com Web: www.sdilasers.com



TDK-Lambda Americas Inc. 405 Essex Road, Neptune, NJ 07753 USA Tel: +1 732 922 9300 Fax: +1 732 922 1441 www.us.tdk-lambda.com/hp

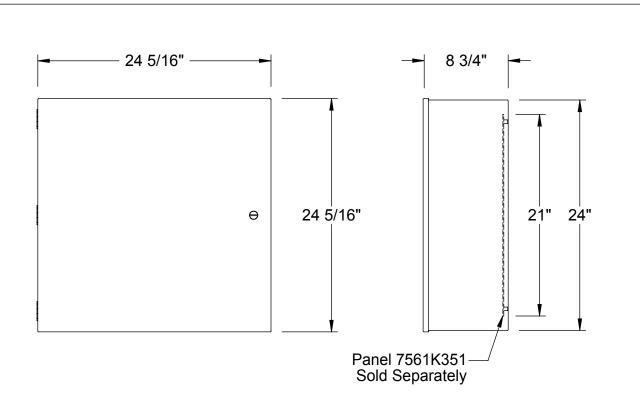


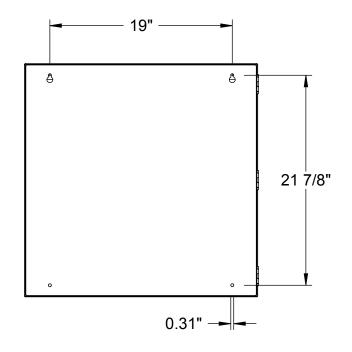
### LEGEND

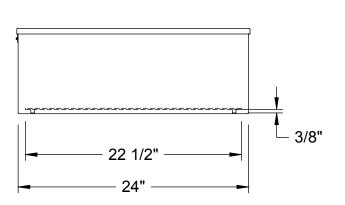
- A. #00 (19 X BARE COPPER COMPACTED), NOMINAL Ø 0.376
- B. SEMICONDUCTING EPR, Ø 0.42
- C. INSULATING EPR Ø 0.115 WALL TO Ø0.65
- D. SEMICONDUCTING EPR, ø 0.70
- E. OUTER CONDUCTOR, DOUBLE LAYER, 12 INCH LAY RHL INNER 41 × #18 AWG (19 × 30AWG T.C.)

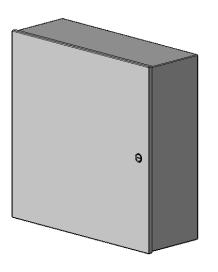
  LHL OUTER 41 × #18 AWG (19 × 30AWG T.C.)
- F. SEMICON TAPE, 2" WIDE, 0.005 THK
- G. INSULATING LDHMW POLYETHYLENE 0.100 WALL.
- H. SEMICON TAPE, 2" WIDE, 0.005 THK
- I. BRAID, #28 AWG T.C., 6 ENDS, 24 CARRIER, 70% COVERAGE.
- J. JACKET, PVC, BLACK, 0.06 WALL.

SCALE SHEET OF							
<b>A</b>   <b>50509</b>	Г	FINISH	ALL MACHINE SURFACES 125V				
DWG NO.			CONCENTRICITY .005 TIR				
HV CABLE		MATERIAL	.xx ±.01 ±				
	DATE	APPROVED	DECIMALS ANGLES				
CHELMSFORD, MASSACHUSETTS 01824	DATE	CHECKED	DIMENSIONS ARE IN INCHES				
DIELECTRIC SCIENCES, INC	DATE 14 JAN16	DRAWN  O. ABDULKY	UNLESS OTHERWISE SPECIFIED	DATE	APPD	ECO NUMBER	REV
ITAINED IN IT ARE THE PROPERTY OF DIELECTRIC SCIENCES, INC AND SHALL AS THE BASIS FOR THE MANUFACTURE OF APPARATUS WITHOUT PERMISSION.	NTAINED IN IT A ) AS THE BASIS	THIS DOCUMENT AND THE INFORMATION CONTROL OF THE REPRODUCED OR COPIED OR USED	THIS DOCUMENT AND NOT BE REPRODUCED		0,	REVISIONS	









14-ga Steel (0.0747") Approximate Internal Dimension: Ht. 23", Wd. 23", Dp. 8 1/8"

McMASTER-CARR®	PART NUMBER	7561K64	
http://www.mcmaster.com © 2014 McMaster-Carr Supply Company		Indoor Steel	
Information in this drawing is provided for reference only	1	Enclosure	